Plastic Darlington Complementary Silicon Power Transistors

These devices are designed for general-purpose amplifier and low-speed switching applications.

Features

- High DC Current Gain $h_{FE} = 2000$ (Typ) @ I_{C} = 2.0 Adc
- Monolithic Construction with Built-in Base-Emitter Resistors to Limit Leakage – Multiplication
- Choice of Packages MJE700 and MJE800 Series
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage MJE700G, MJE800G MJE702G, MJE703G, MJE802G, MJE803G	V _{CEO}	60 80	Vdc
Collector–Base Voltage MJE700G, MJE800G MJE702G, MJE703G, MJE802G, MJE803G	V _{CB}	60 80	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current	I _C	4.0	Adc
Base Current	I _B	0.1	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	40 0.32	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

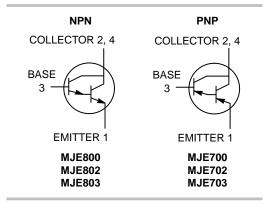
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	3.12	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	83.3	°C/W



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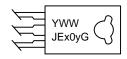
http://onsemi.com

4.0 AMPERE DARLINGTON POWER TRANSISTORS COMPLEMENTARY SILICON 40 WATT





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•	
Collector–Emitter Breakdown Voltage (Note 1) (I _C = 50 mAdc, I _B = 0) MJE700G, MJE800G MJE702G, MJE703G, MJE802G, MJE803G	V _(BR) CEO	60 80	-	Vdc
Collector Cutoff Current $(V_{CE}=60\ Vdc,\ I_B=0)$ MJE700G, MJE800G $(V_{CE}=80\ Vdc,\ I_B=0)$ MJE702G, MJE703G, MJE802G, MJE803G	lceo	-	100 100	μAdc
Collector Cutoff Current $(V_{CB} = \text{Rated BV}_{CEO}, I_E = 0)$ $(V_{CB} = \text{Rated BV}_{CEO}, I_E = 0, T_C = 100^{\circ}\text{C})$	I _{CBO}	- -	100 500	μAdc
Emitter Cutoff Current (V _{BE} = 5.0 Vdc, I _C = 0)	I _{EBO}	-	2.0	mAdc
ON CHARACTERISTICS	·		·	·
DC Current Gain (Note 1) $ \begin{array}{l} (I_C = 1.5 \ \text{Adc}, \ V_{CE} = 3.0 \ \text{Vdc}) \\ \text{MJE700G}, \ \text{MJE702G}, \ \text{MJE800G}, \ \text{MJE802G} \\ (I_C = 2.0 \ \text{Adc}, \ V_{CE} = 3.0 \ \text{Vdc}) \\ \text{MJE703G}, \ \text{MJE803G} \\ (I_C = 4.0 \ \text{Adc}, \ V_{CE} = 3.0 \ \text{Vdc}) \\ \text{All devices} \end{array} $	h _{FE}	750 750 100	- - -	_
Collector–Emitter Saturation Voltage (Note 1) $ \begin{aligned} &(I_C=1.5 \text{ Adc, } I_B=30 \text{ mAdc}) \\ &\text{MJE700G, MJE702G, MJE800G, MJE802G} \\ &(I_C=2.0 \text{ Adc, } I_B=40 \text{ mAdc}) \\ &\text{MJE703G, MJE803G} \\ &(I_C=4.0 \text{ Adc, } I_B=40 \text{ mAdc}) \\ &\text{All devices} \end{aligned} $	V _{CE(sat)}	- - -	2.5 2.8 3.0	Vdc
$\label{eq:Base-Emitter On Voltage (Note 1)} Base-Emitter On Voltage (Note 1) \\ (I_C = 1.5 \ Adc, \ V_{CE} = 3.0 \ Vdc) \\ MJE700G, \ MJE702G, \ MJE800G, \ MJE802G \\ (I_C = 2.0 \ Adc, \ V_{CE} = 3.0 \ Vdc) \\ MJE703G, \ MJE803G \\ (I_C = 4.0 \ Adc, \ V_{CE} = 3.0 \ Vdc) \\ All \ devices$	V _{BE(on)}	- - -	2.5 2.5 3.0	Vdc
DYNAMIC CHARACTERISTICS	ı		-1	
Small–Signal Current Gain (I _C = 1.5 Adc, V _{CE} = 3.0 Vdc, f = 1.0 MHz)	h _{fe}	1.0	_	-

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

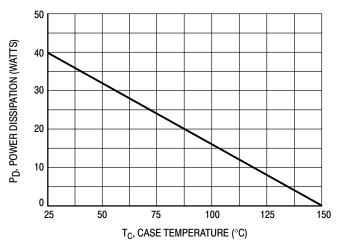


Figure 1. Power Derating

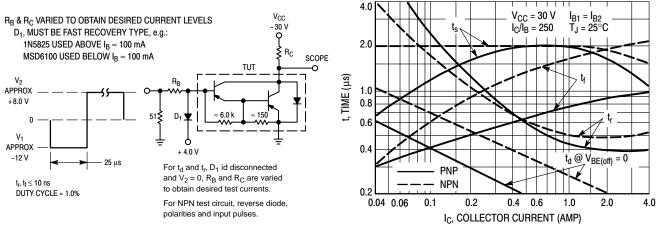


Figure 2. Switching Times Test Circuit

Figure 3. Switching Times

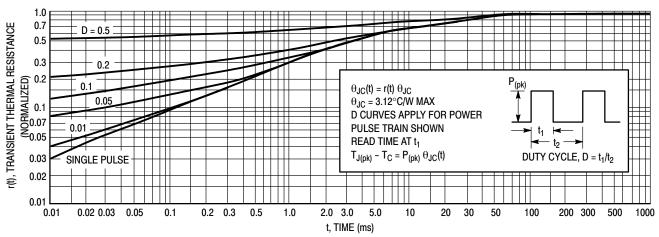
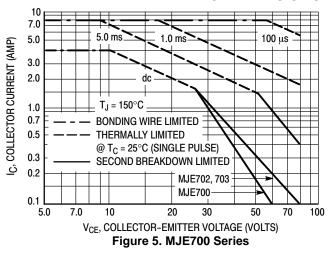
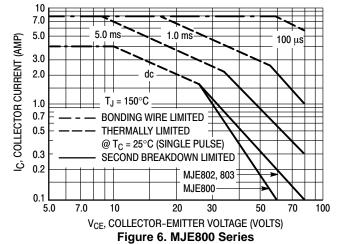


Figure 4. Thermal Response (MJE700, 800 Series)

ACTIVE-REGION SAFE-OPERATING AREA



There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.



The data of Figures 5 and 6 are based on $T_{J(pk)}=150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)}$ < $150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

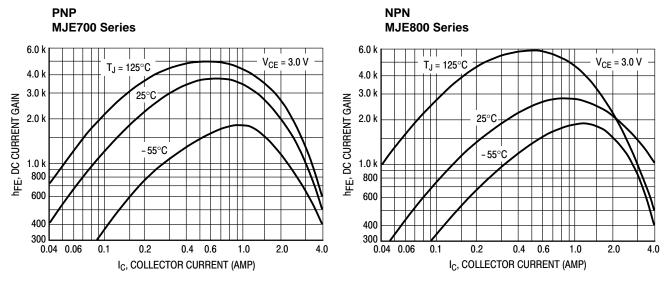


Figure 7. DC Current Gain

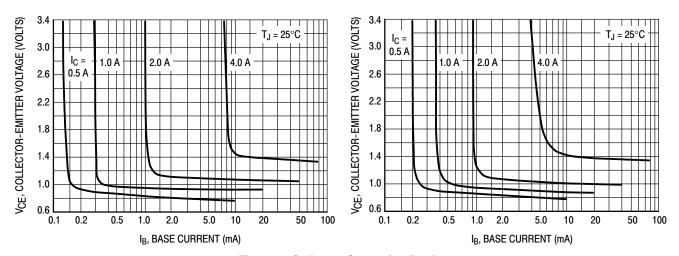


Figure 8. Collector Saturation Region

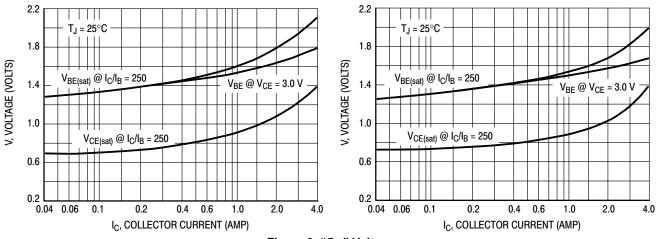
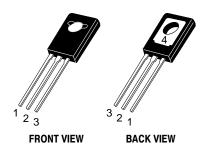


Figure 9. "On" Voltages

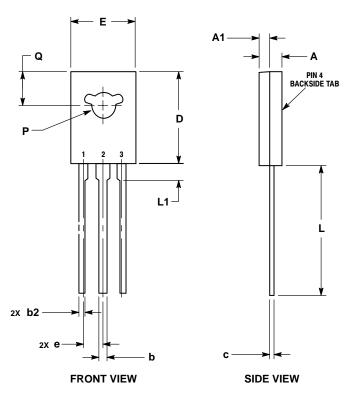
ORDERING INFORMATION

Device	Package	Shipping
MJE700G	TO-225 (Pb-Free)	50 Units / Bulk
MJE702G	TO-225 (Pb-Free)	50 Units / Bulk
MJE703G	TO-225 (Pb-Free)	50 Units / Bulk
MJE800G	TO-225 (Pb-Free)	50 Units / Bulk
MJE802G	TO-225 (Pb-Free)	50 Units / Bulk
MJE803G	TO-225 (Pb-Free)	50 Units / Bulk

PACKAGE DIMENSIONS



TO-225 CASE 77-09 **ISSUE AC**



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. NUMBER AND SHAPE OF LUGS OPTIONAL.

	MILLIMETERS	
DIM	MIN	MAX
Α	2.40	3.00
A1	1.00	1.50
b	0.60	0.90
b2	0.51	0.88
С	0.39	0.63
D	10.60	11.10
Е	7.40	7.80
е	2.04	2.54
L	14.50	16.63
L1	1.27	2.54
Р	2.90	3.30
Q	3.80	4.20

STYLE 1:

PIN 1. EMITTER 2., 4. COLLECTOR

BASE

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